Notice for TAIYO YUDEN products

Please read this notice before using the TAIYO YUDEN products.

/!\ REMINDERS

Product Information in this Catalog

Product information in this catalog is as of January 2021. All of the contents specified herein and production status of the products listed in this catalog are subject to change without notice due to technical improvement of our products, etc. Therefore, please check for the latest information carefully before practical application or use of our products.

Please note that TAIYO YUDEN shall not be in any way responsible for any damages and defects in products or equipment incorporating our products, which are caused under the conditions other than those specified in this catalog or individual product specification sheets.

Approval of Product Specifications

Please contact TAIYO YUDEN for further details of product specifications as the individual product specification sheets are available. When using our products, please be sure to approve our product specifications or make a written agreement on the product specification with TAIYO YUDEN in advance.

Pre-Evaluation in the Actual Equipment and Conditions

Please conduct validation and verification of our products in actual conditions of mounting and operating environment before using our products.

Limited Application

1. Equipment Intended for Use

The products listed in this catalog are intended for general-purpose and standard use in general electronic equipment (e.g., AV equipment, OA equipment, home electric appliances, office equipment, information and communication equipment including, without limitation, mobile phone, and PC) and other equipment specified in this catalog or the individual product specification sheets.

TAIYO YUDEN has the line-up of the products intended for use in automotive electronic equipment, telecommunications infrastructure and industrial equipment, or medical devices classified as GHTF Classes A to C (Japan Classes I to III). Therefore, when using our products for these equipment, please check available applications specified in this catalog or the individual product specification sheets and use the corresponding products.

2. Equipment Requiring Inquiry

Please be sure to contact TAIYO YUDEN for further information before using the products listed in this catalog for the following equipment (excluding intended equipment as specified in this catalog or the individual product specification sheets) which may cause loss of human life, bodily injury, serious property damage and/or serious public impact due to a failure or defect of the products and/or malfunction attributed thereto.

- (1) Transportation equipment (automotive powertrain control system, train control system, and ship control system, etc.)
- (2) Traffic signal equipment
- (3) Disaster prevention equipment, crime prevention equipment
- (4) Medical devices classified as GHTF Class C (Japan Class III)
- (5) Highly public information network equipment, dataprocessing equipment (telephone exchange, and base station, etc.)
- (6) Any other equipment requiring high levels of quality and/or reliability equal to the equipment listed above

3. Equipment Prohibited for Use

Please do not incorporate our products into the following equipment requiring extremely high levels of safety and/or reliability.

- (1) Aerospace equipment (artificial satellite, rocket, etc.)
- (2) Aviation equipment *1
- (3) Medical devices classified as GHTF Class D (Japan Class IV), implantable medical devices *2

- (4) Power generation control equipment (nuclear power, hydroelectric power, thermal power plant control system, etc.)
- (5) Undersea equipment (submarine repeating equipment, underwater work equipment, etc.)
- (6) Military equipment
- (7) Any other equipment requiring extremely high levels of safety and/or reliability equal to the equipment listed above

*Notes:

- 1. There is a possibility that our products can be used only for aviation equipment that does not directly affect the safe operation of aircraft (e.g., in-flight entertainment, cabin light, electric seat, cooking equipment) if such use meets requirements specified separately by TAIYO YUDEN. Please be sure to contact TAIYO YUDEN for further information before using our products for such aviation equipment.
- Implantable medical devices contain not only internal unit which is implanted in a body, but also external unit which is connected to the internal unit.

4. Limitation of Liability

Please note that unless you obtain prior written consent of TAIYO YUDEN, TAIYO YUDEN shall not be in any way responsible for any damages incurred by you or third parties arising from use of the products listed in this catalog for any equipment that is not intended for use by TAIYO YUDEN, or any equipment requiring inquiry to TAIYO YUDEN or prohibited for use by TAIYO YUDEN as described above.

Safety Design

When using our products for high safety and/or reliability-required equipment or circuits, please fully perform safety and/or reliability evaluation. In addition, please install (i) systems equipped with a protection circuit and a protection device and/or (ii) systems equipped with a redundant circuit or other system to prevent an unsafe status in the event of a single fault for a failsafe design to ensure safety.

Intellectual Property Rights

Information contained in this catalog is intended to convey examples of typical performances and/or applications of our products and is not intended to make any warranty with respect to the intellectual property rights or any other related rights of TAIYO YUDEN or any third parties nor grant any license under such rights.

Limited Warranty

Please note that the scope of warranty for our products is limited to the delivered our products themselves and TAIYO YUDEN shall not be in any way responsible for any damages resulting from a failure or defect in our products. Notwithstanding the foregoing, if there is a written agreement (e.g., supply and purchase agreement, quality assurance agreement) signed by TAIYO YUDEN and your company, TAIYO YUDEN will warrant our products in accordance with such agreement

■ TAIYO YUDEN's Official Sales Channel

The contents of this catalog are applicable to our products which are purchased from our sales offices or authorized distributors (hereinafter "TAIYO YUDEN's official sales channel"). Please note that the contents of this catalog are not applicable to our products purchased from any seller other than TAIYO YUDEN's official sales channel.

Caution for Export

2021

Some of our products listed in this catalog may require specific procedures for export according to "U.S. Export Administration Regulations", "Foreign Exchange and Foreign Trade Control Law" of Japan, and other applicable regulations. Should you have any questions on this matter, please contact our sales staff.

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Automotive Application Guide

We classify automotive electronic equipment into the following four application categories and set usable application categories for each of our products. When using our products for automotive electronic equipment, please be sure to check such application categories and use our products accordingly. Should you have any questions on this matter, please contact us.

Category	Automotive Electronic Equipment (Typical Example)
POWERTRAIN	 Engine ECU (Electronically Controlled Fuel Injector) Cruise Control Unit 4WS (4 Wheel Steering) Transmission Power Steering HEV/PHV/EV Core Control (Battery, Inverter, DC-DC)
SAFETY	 Automotive Locator (Car location information providing device), etc. ABS (Anti-Lock Brake System) ESC (Electronic Stability Control) Airbag ADAS (Equipment that directly controls running, turning and stopping), etc.
BODY & CHASSIS	Wiper Automatic Door Power Window Keyless Entry System Electric Door Mirror Automobile Digital Mirror Interior Lighting Automobile Air Conditioning System LED Headlight TPMS (Tire Pressure Monitoring System) Anti-Theft Device (Immobilizer), etc.
INFOTAINMENT	 Car Infotainment System ITS/Telematics System Instrument Cluster ADAS (Sensor, Equipment that is not interlocked with safety equipment or powertrain) Dashcam (genuine products for automotive manufacturer), etc.

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CHIP BEAD INDUCTORS FOR POWER LINES (FB SERIES M TYPE)

AEC-Q200 Grade 3 (we conduct the evaluation at the test condition of Grade 3.)

*Operating environment Temp:-40~85°C



■PART NUMBER

*Operating Temp. : -40~125°C (Including self-generated heat)



△=Blank space

①Seri	es	name	
	_		

O	
Code	Series name
FB	Ferrite bead

2 Shane

E Chapo	
Code	Shape
M	Rectangular chip

3Characteristics

Code	Characteristics
J	Standard
Н	High Impedance type

6 Nominal impedance

(5)Material Code

HS

НМ

HL

Code (example)	Nominal impedance[Ω]
330	33
221	220
102	1000

Material

Refer to impedance curves

for material differences

(A)Dimensions (I × W)

(4)Dimensions (L × W)					
Code	Type (inch)	Dimensions (L×W)[mm]			
1608	1608 (0603)	1.6 × 0.8			
2125	2125(0805)	2.0 × 1.25			
2012	2012 (0805)	2.0 ^ 1.25			
2016	2016 (0806)	2.0 × 1.6			
3216	3216(1206)	3.2 × 1.6			
3225	3225(1210)	3.2 × 2.5			
4516	4516 (1806)	4.5 × 1.6			
4525	4525(1810)	4.5 × 2.5			

7 Impedance tolerance

\circ .	
Code	Impedance tolerance
_	±25%
N	±30%

®Packaging

Code	Packaging
Т	Taping

9Internal code

Code	Internal code	
V	Dead Industry for Automatics	
W	Bead Inductor for Automotive	
8	Bead Inductor for Telecommunications infrastructure	
	and Industrial equipment / Medical devices	

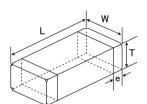
FEATURES

HS: For broadband applications

HM: For upper MHz range applications

HL: For GHz range applications

STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns

Surface Mounting

·Mounting and soldering conditions should be checked beforehand.



Type	A	В	C
FB MJ1608	1.0	1.0	1.0
FB MJ2125	1.4	1.2	1.65
FB MJ3216	1.4	2.2	2.0
FB MJ4516	1.75	3.5	2.0
FB MH1608	1.0	1.0	1.0
FB MH2012	1.4	1.2	1.65
FB MH2016	1.4	1.2	2.0
FB MH3216	1.4	2.2	2.0
FB MH3225	1.4	2.2	2.9
FB MH4516	1.75	3.5	2.0
FB MH4525	1.75	3.5	2.9

Unit:mm

Time	1	W	Т	_	Standard qu	antity [pcs]
Туре	L	VV	l l	е	Paper tape	Embossed tape
FB MJ1608 (0603)	1.6±0.2 (0.063±0.008)	0.8±0.2 (0.031±0.008)	0.8±0.2 (0.031±0.008)	0.3±0.2 (0.012±0.008)	4000	_
FB MJ2125 (0805)	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	0.85±0.2 (0.033±0.008)	0.5±0.3 (0.020±0.012)	4000	_
FB MJ3216 (1206)	3.2±0.3 (0.126±0.012)	1.6±0.2 (0.063±0.008)	1.1±0.2 (0.043±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MJ4516 (1806)	4.5±0.3 (0.177±0.012)	1.6±0.2 (0.063±0.008)	1.1±0.2 (0.043±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MH1608 (0603)	1.6±0.1 (0.063±0.004)	0.8±0.1 (0.031±0.004)	0.8±0.1 (0.031±0.004)	0.3±0.15 (0.012±0.006)	4000	_
FB MH2012 (0805)	2.0±0.2 (0.079±0.008)	1.25±0.2 (0.049±0.008)	0.85±0.2 (0.033±0.008)	0.5±0.3 (0.020±0.012)	4000	_
FB MH2016 (0806)	2.0±0.2 (0.079±0.008)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MH3216 (1206)	3.2±0.3 (0.126±0.012)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MH3225 (1210)	3.2±0.3 (0.126±0.012)	2.5±0.3 (0.098±0.012)	2.5±0.3 (0.098±0.012)	0.5±0.3 (0.020±0.012)	_	1000
FB MH4516 (1806)	4.5±0.3 (0.177±0.012)	1.6±0.2 (0.063±0.008)	1.6±0.2 (0.063±0.008)	0.5±0.3 (0.020±0.012)	_	2000
FB MH4525 (1810)	4.5±0.4 (0.177±0.016)	2.5±0.3 (0.098±0.012)	2.5±0.3 (0.098±0.012)	0.9±0.6 (0.035±0.024)	_	1000
						Unit:mm(inch)

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PART NUMBER

· All the Chip Bead Inductors for Power Lines of the catalog lineup are RoHS compliant.

- The exchange of individual specifications is necessary depending on your application and/or circuit condition. Please contact TAIYO YUDEN's official sales channel.
- For Automotive (AEC-Q200 Qualified) products for BODY & CHASSIS, and INFOTAINMENT. Please check "Automotive Application Guide" for further details before using the products. < AEC-Q200 : AEC-Q200 qualified>

All the Chip Bead Inductors for Power Lines for Automotive products are tested based on the test conditions and methods defined in AEC-Q200 by family item. Please consult with TAIYO YUDEN's official sales channel for the details of the product specifications and AEC-Q200 test results, etc., and please review and approve the product specifications before ordering.

Standard type

FB MJ1608

Part numb	er	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MJ1608HS2	BONTV	28	±30%	100	0.007	4.0	0.8 ±0.2	
FB MJ1608HM2	30NTV	23	±30%	100	0.007	4.0	0.8 ±0.2	

●FB MJ2125

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MJ2125HS250NTV	25	±30%	100	0.004	6.0	0.85 ±0.2	
FB MJ2125HS420-TV	42	±25%	100	0.008	4.0	0.85 ±0.2	
FB MJ2125HM210NTV	21	±30%	100	0.004	6.0	0.85 ±0.2	
FB MJ2125HM330-TV	33	±25%	100	0.008	4.0	0.85 ±0.2	
FB MJ2125HL8R0NTV	8	±30%	100	0.008	4.0	0.85 ±0.2	

●FB MJ3216

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MJ3216HS480NTV	48	±30%	100	0.005	6.0	1.1 ±0.2	
FB MJ3216HS800-TV	80	±25%	100	0.010	4.0	1.1 ±0.2	
FB MJ3216HM380NTV	38	±30%	100	0.005	6.0	1.1 ±0.2	
FB MJ3216HM600-TV	60	±25%	100	0.010	4.0	1.1 ±0.2	
FB MJ3216HL160NTV	16	±30%	100	0.012	4.0	1.1 ±0.2	

FB MJ4516

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MJ4516HS720NTV	72	±30%	100	0.007	6.0	1.1 ±0.2	
FB MJ4516HS111-TV	110	±25%	100	0.014	4.0	1.1 ±0.2	
FB MJ4516HM560NTV	56	±30%	100	0.007	6.0	1.1 ±0.2	
FB MJ4516HM900-TV	90	±25%	100	0.014	4.0	1.1 ±0.2	
FB MJ4516HL230NTV	23	±30%	100	0.014	3.5	1.1 ±0.2	

High impedance type (GHz Band)

●FR MH1608

Part number	Nominal imped Measuring frequency		Nominal impeda Measuring frequence		DC Resistance	Rated current	Thickness [mm]	Note
	(Ω)	tolerance	(Ω)	tolerance	L 3E 3 (IIIAX.)	[A] (IIIax.)	[IIIIII]	
FB MH1608HM470-TV	47	±25%	75	±40%	0.020	3.5	0.8 ±0.1	
FB MH1608HM600-TV	60	±25%	100	±40%	0.025	3.0	0.8 ±0.1	
FB MH1608HM101-TV	100	±25%	170	±40%	0.035	2.5	0.8 ±0.1	
FB MH1608HM151-TV	150	±25%	270	±40%	0.050	2.1	0.8 ±0.1	
FB MH1608HM221-TV	220	±25%	370	±40%	0.070	1.8	0.8 ±0.1	
FB MH1608HM331-TV	330	±25%	520	±40%	0.130	1.2	0.8 ±0.1	
FB MH1608HM471-TV	470	±25%	750	±40%	0.150	1.0	0.8 ± 0.1	
FB MH1608HM601-TV	600	±25%	900	±40%	0.170	0.9	0.8 ± 0.1	
FB MH1608HM102-TV	1000	±25%	1200	±40%	0.350	0.6	0.8 ± 0.1	
FB MH1608HL300-TV	30	±25%	120	±40%	0.028	2.6	0.8 ± 0.1	
FB MH1608HL600-TV	60	±25%	220	±40%	0.045	2.1	0.8 ± 0.1	
FB MH1608HL121-TV	120	±25%	540	±40%	0.130	1.2	0.8 ± 0.1	
FB MH1608HL221-TV	220	±25%	950	±40%	0.170	0.9	0.8 ± 0.1	
FB MH1608HL331-TV	330	±25%	1200	±40%	0.210	0.8	0.8 ±0.1	
FB MH1608HL471-TV	470	±25%	1500	±40%	0.350	0.6	0.8 ±0.1	
FB MH1608HL601-TV	600	±25%	1800	±40%	0.450	0.5	0.8 ±0.1	

*) The rated current is the value of current at which the temperature of the element is increased by 40 deg.

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■PART NUMBER

High impedance type

for High Quality Equipment

	H2	

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MH2012HM800-TV	80	±25%	100	0.025	2.7	0.85 ±0.2	
FB MH2012HM121-TV	120	±25%	100	0.032	2.5	0.85 ±0.2	
FB MH2012HM221-TV	220	±25%	100	0.060	2.0	0.85 ± 0.2	
FB MH2012HM331-TV	330	±25%	100	0.080	1.8	0.85 ±0.2	

●FB MH2016

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MH2016HM121NTV	120	±30%	100	0.015	4.5	1.6 ±0.2	
FB MH2016HM251NTV	250	±30%	100	0.050	2.0	1.6 ±0.2	

●FB MH3216

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MH3216HM221NTV	220	±30%	100	0.020	4.0	1.6 ±0.2	
FB MH3216HM501NTV	500	±30%	100	0.070	2.0	1.6 ±0.2	

FB MH3225

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note	
FB MH3225HM601NTV	600	±30%	100	0.042	3.0	2.5 ±0.3		
FB MH3225HM102NTV	1000	±30%	100	0.100	2.0	2.5 ±0.3		
FB MH3225HM202NTV	2000	±30%	100	0.130	1.2	2.5 ±0.3		

●FB MH4516

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance $[\Omega]$ (max.)	Rated current [A] (max.)	Thickness [mm]	Note
FR MH4516HM851NTV	850	+30%	100	0.100	1.5	16 +02	

FB MH4525

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω] (max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MH4525HM102NTV	1000	±30%	100	0.060	3.0	2.5 ±0.3	
FB MH4525HM162NTV	1600	±30%	100	0.130	2.0	2.5 ±0.3	

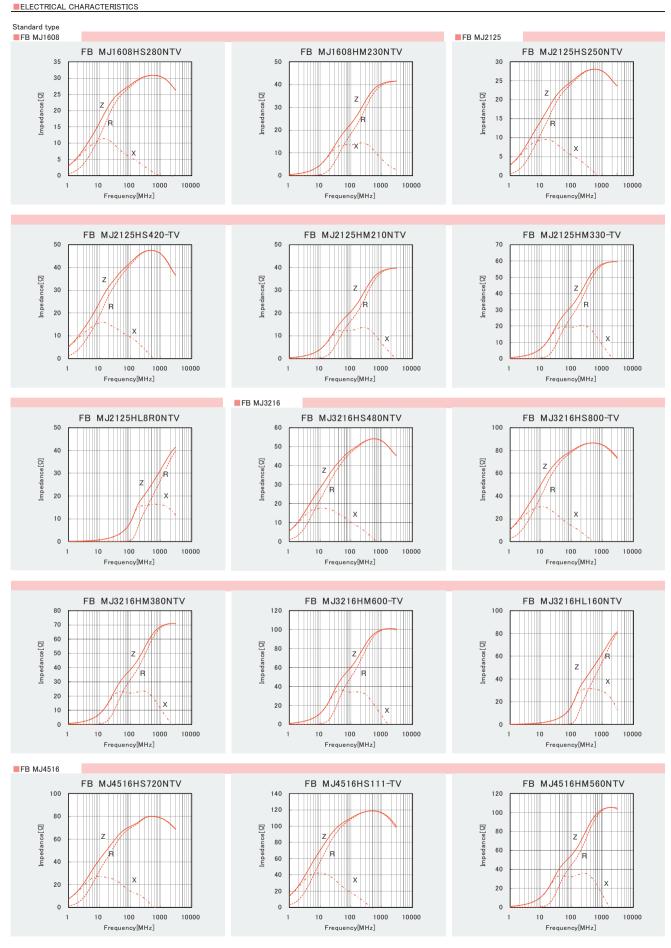
High current type

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB MJ1608HS220NTW	22	±30%	100	0.004	7.5	0.8 ±0.2	
FB MJ1608HS280NTW	28	±30%	100	0.006	6.0	0.8 ±0.2	
FB MJ1608HM180NTW	18	±30%	100	0.004	7.5	0.8 ± 0.2	
FB MJ1608HM230NTW	23	±30%	100	0.006	6.0	0.8 ±0.2	

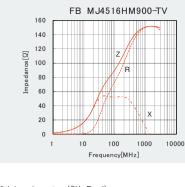
*X) The rated current is the value of current at which the temperature of the element is increased by 40 deg.

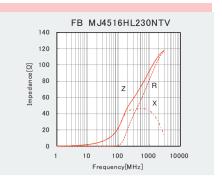
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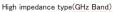
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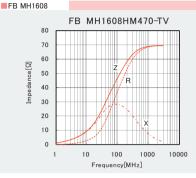


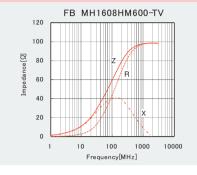
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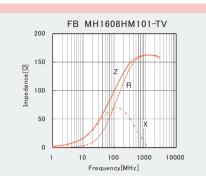


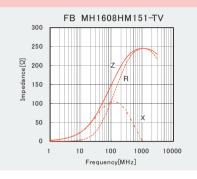


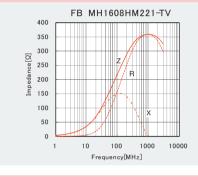


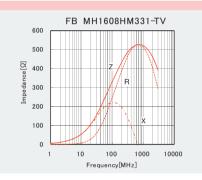


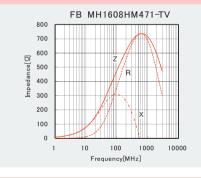


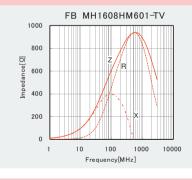


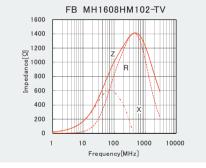


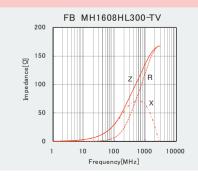


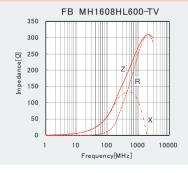


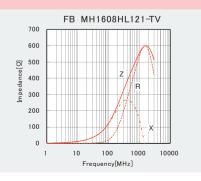




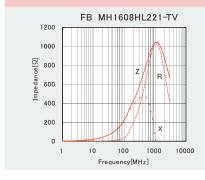


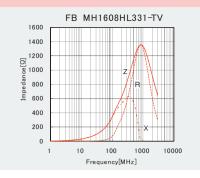


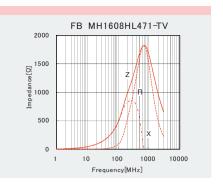


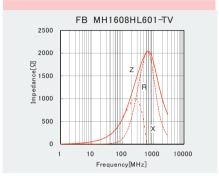


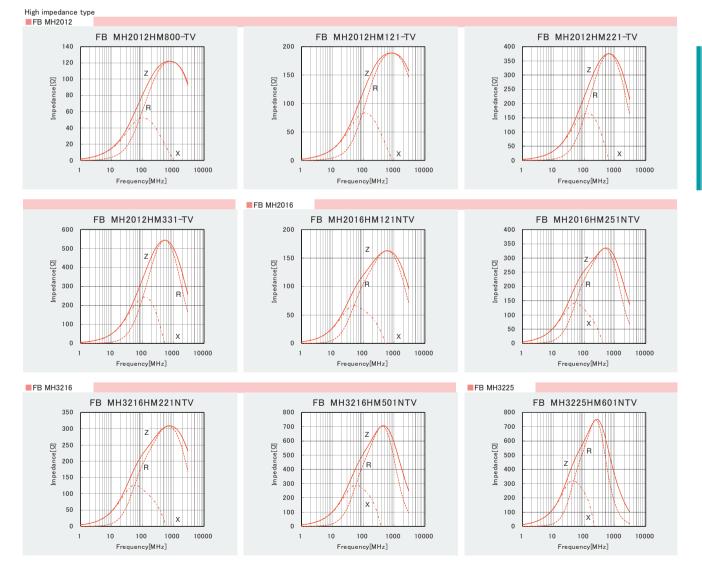
[▶] This catalog contains the typical specification only due to the limitation of space. When you consider the purchase of our products, please check our product specification sheets. For details of each product (characteristics graph, reliability information, precautions for use, and so on), see our website (http://www.ty-top.com/).



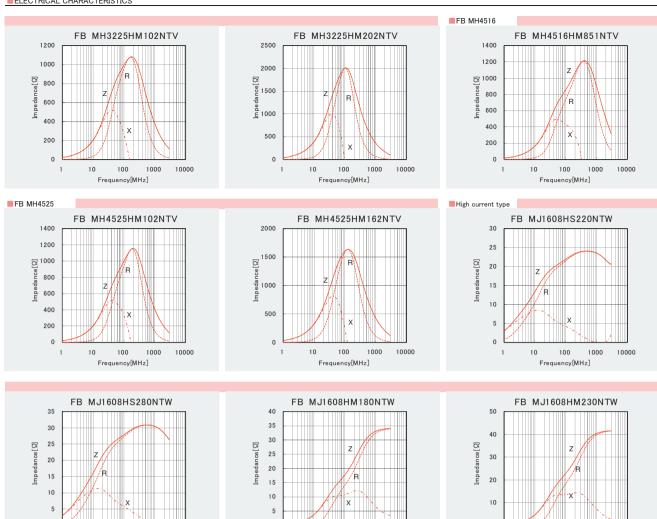








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10

100

Frequency[MHz]

1000

10000

Derating of Rated Current

0

10

100

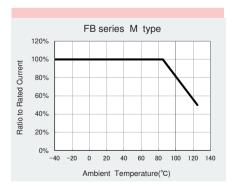
Frequency[MHz]

●FB series M type

Derating of current is necessary for FB series M type depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.

1000

10000



10000

10

100

Frequency[MHz]

1000

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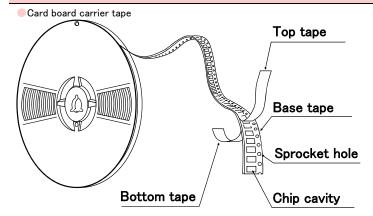
CHIP BEAD INDUCTORS FOR POWER LINES (FB SERIES M TYPE / T TYPE)

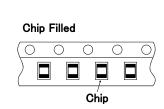
PACKAGING

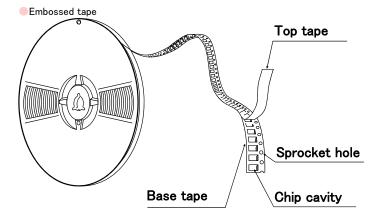
1 Minimum Quantity

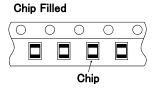
Type	Standard Quantity[pcs]		
туре	Paper Tape	Embossed Tape	
1608 (0603)	4000	1	
2125 (0805)	4000	1	
2012 (0805)	4000	ı	
2016 (0806)	_	2000	
3216(1206)	_	2000	
3225 (1210)	_	1000	
4516(1806)	_	2000	
4525(1810)	_	1000	
4532(1812)	_	2000	

2 Tape Material



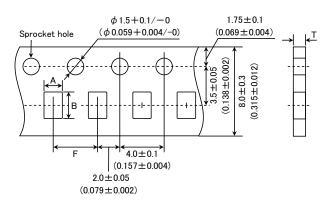






3Taping Dimensions

Paper tape (0.315 inches wide)

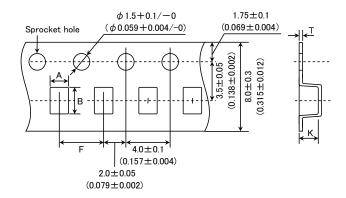


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Туре	Chip	Cavity	Insertion Pitch	Tape Thickness
туре	Α	В	F	Т
FB MJ1608				
FB MH1608	1.0 ± 0.2	1.8±0.2	4.0 ± 0.2	1.1max
FB TH1608	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.008)	(0.043max)
(0603)				
FB MJ2125	1.5±0.2	2.3±0.2	4.0±0.2	1.1max
FB MH2012	(0.059 ± 0.008)	(0.091±0.008)	(0.157±0.008)	(0.043max)
(0805)	(0.039 ± 0.006)	(0.031 ± 0.006)	(0.137 ± 0.006)	(0.043111ax)

Unit: mm(inch)

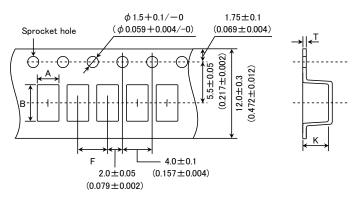
Embossed tape (0.315 inches wide)



Tumo	Chip (Cavity	Insertion Pitch	Tape Th	nickness
Туре	Α	В	F	K	Т
FB MH2016	1.8±0.2	2.2±0.2	4.0±0.2	2.6max	0.6max
(0806)	(0.071 ± 0.008)	(0.087 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FB MJ3216	1.9±0.2	3.5±0.2	4.0±0.2	1.5max	0.3max
(1206)	(0.075 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.059max)	(0.012max)
FB MH3216	1.9±0.2	3.5±0.2	4.0±0.2	2.6max	0.6max
(1206)	(0.075 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FB MH3225	2.8±0.2	3.5±0.2	4.0±0.2	4.0max	0.6max
(1210)	(0.110 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.157max)	(0.024max)

Unit: mm(inch)

Embossed tape (0.472 inches wide)

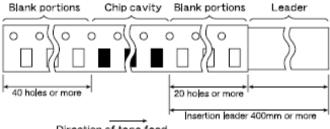


T	Chip Cavity		Insertion Pitch	Tape Thickness	
Туре	A	В	F	K	Т
FB MJ4516	1.9±0.2	4.9±0.2	4.0±0.2	1.5max	0.3max
(1806)	(0.075 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.059max)	(0.012max)
FB MH4516	1.9±0.2	4.9±0.2	4.0±0.2	2.6max	0.6max
(1806)	(0.075 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FB MH4525	2.9±0.2	4.9±0.2	4.0±0.2	4.0max	0.6max
(1810)	(0.114 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.157max)	(0.024max)
FB MH4532	3.6±0.2	4.9±0.2	8.0±0.2	4.0max	0.6max
(1812)	(0.142 ± 0.008)	(0.193 ± 0.008)	(0.315 ± 0.008)	(0.157max)	(0.024max)

Unit: mm(inch)

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4 Leader and Blank portion

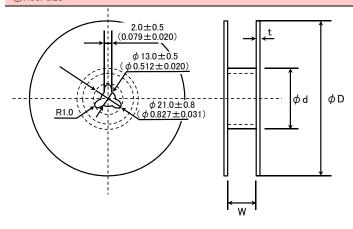


Direction of tape feed

Insertion leader is 400 mm or more (including 20 empty cavities)

Empty cavities at end of reel: 40 holes or more

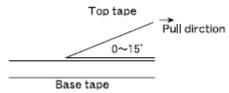
5Reel size



Туре	ΦD	¢ d	W	t
FB MJ1608			10.0±1.5	
FB MJ2125			(0.394 ± 0.059)	
FB MJ3216			(0.394 ± 0.039)	
FB MJ4516			14.0±1.5 (0.551±0.059)	
FB MH1608	180+0/-3	60+1/-0		2.5max
FB MH2012	(7.09+0/-0.118)	(2.36+0.039/-0)	10.0±1.5	(0.098max)
FB MH2016			(0.394 ± 0.059)	
FB MH3216			(0.394 ± 0.039)	
FB MH3225				
FB MH4516			14.0±1.5	
FB MH4525			(0.551 ± 0.059)	
FB MH4532	330±2.0 (12.99±0.080)	100±1.0 (3.94±0.039)	14.0±2.0 (0.551±0.080)	3.0max (1.181max)
ED T111000	180+0/-3	60+1/-0	10.0±1.5	2.5max
FB TH1608	(7.09+0/-0.118)	(2.36+0.039/-0)	(0.394 ± 0.059)	(0.098max)

Unit: mm(inch)

6Top tape strength



The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.

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CHIP BEAD INDUCTORS FOR POWER LINE (FB SERIES M TYPE)

■RELIABILITY DATA

1. Operating Tempe	rature Range	
Specified Value	-40°C~+125°C (Inc	luding self-generated heat)
Test Methods and Remarks	Including self-generated	d heat
2. Storage Tempera	iture Range	
Specified Value	-40°C~+85°C	
Test Methods and Remarks	*Note: -5 to +40°C	in taped packaging
3. Impedance		
Specified Value	Within the specified ran	ge
Test Methods and Remarks	Measuring equipment Measuring frequency	: Impedance analyzer (HP4291A) or its equivalent : 100±1 MHz
4. DC Resistance	T	
Specified Value	Within the specified ran	ge
Test Methods and Remarks	Four-terminal method Measuring equipment : I	Milliohm High-Tester 3226 (Hioki Denki) or its equivalent
5 D . 10		
5. Rated Current		
Specified Value	Within the specified ran	ge
6. Vibration	T	
Specified Value	Appearance Impedance change	: No significant abnormality : Within $\pm 30\%$ of the initial value
	The test samples shall	pe soldered to the test board by the reflow.
		ed to below test conditions.
	Frequency	10~2000Hz
Test Methods and Remarks	Total Amplitude Sweeping Method	5G 20min(10→2000→10Hz)
Nemarks	Owceping Method	X X
	Time	Y 4hours Z
7. Solderability		
Specified Value	90% or more of immerse	ed surface of terminal electrode shall be covered with fresh solder.
	Solder Temperature	230±5°C
Test Methods and	Time	4±1sec
Remarks	Preconditioning	Immersion into flux.
	Immersing Speed	25mm/sec

8. Resistance to Soldering Heat

Specified Value	• •	No significant abnormality Within $\pm 30\%$ of the initial value	
	Preheating	150°C 3min	
	Solder Temperature	260±5°C	
Test Methods and	Time	30±0.5sec	
Remarks	Preconditioning	Immersion into flux.	
	Immersing Speed	25mm/s	
	The measurement, after th	e test, shall be carried out the test sample has be	en left for 2 to 3 hours.

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9. Thermal Shock : No significant abnormality Appearance Specified Value : Within $\pm 50/-10\%$ of the initial value Impedance change Conditions for 1 cycle Step Temperature (°C) Duration (min.) -40±3°C 30 ± 3 2 Room Temperature Within 3 Test Methods and 125±2°C 3 30±3 Remarks 4 Room Temperature Within 3 Number of cycles : Soldering onto PC board Mounting method The measurement, after the test, shall be carried out the test sample has been left for 2 to 3 hours.

10. Resistance to H	umidity (steady state	e)	
Specified Value	Appearances Impedance change	: No significant abnormality : Within $\pm 30\%$ of the initial value	
Test Methods and Remarks	•	hall be soldered to the test board by the hall be placed in thermostatic oven set $40\pm2^{\circ}\text{C}$ $90\sim95\%\text{RH}$ $1000+24/-0$ hour	e reflow. at specified temperature and humidity as shown in below table.
	The measurement,	after the test, shall be carried out the t	test sample has been left for 2 to 3 hours.

11. Loading under D	amp Heat		
Specified Value	Appearance Impedance change	No ignificant abnormality Within $\pm 30\%$ of the initial value	
Test Methods and Remarks	The test samples st shown in below table Temperature Humidity Applied current Time	85±2°C 85%RH Rated current 1000+24/-0 hour	e reflow soldering. t specified temperature, humidity, and applied the rated current continuously as est sample has been left for 2 to 3 hours.

	re Loading Test		
Specified Value	Appearance	: No significant abnormality	
Specified value	Impedance change	: Within $\pm 30\%$ of the initial valu	е
	· ·	hall be soldered to the test board by	<u> </u>
	The test samples s	hall be placed in thermostatic oven se	at specified temperature and applied the rated current continuously as shown in
T . M .:	below table.		
Test Methods and Remarks	Temperature	85±2°C	
Remarks	Applied current	Rated current	
	Time	1000 + 24/-0 hour	
	The measurement	after the test shall be carried out the	test sample has been left for 2 to 3 hours.

Specified Value	Appearance : No mechanical damage.	
Test Methods and Remarks	The test samples shall be soldered to the test be indicating until deflection of the test board reach Warp : 2mm Testing board : Glass epoxy-resin substrate Thickness : 0.8mm	pard by the reflow. As illustrated below, apply force in the direction of the arrow nes to 2 mm. Force Rod 10 R230 Board Test Sample 45±2mm 45±2mm

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14. Adhesion of Elec	ctrode	
Specified Value No separation or indication of separation of electrode.		
Test Methods and	Applied force : 17.7N	
Remarks	Duration : 10 sec.	

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to $35^{\circ}\text{C}\,$ of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}\text{C}$ of temperature, 60 to 70% relative humidity and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

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CHIP BEAD INDUCTORS FOR POWER LINE (FB SERIES M TYPE / T TYPE)

PRECAUTIONS

1. Circuit Design

◆Operating environment

The products listed in this catalogue are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric
appliances, office equipment, information and communication equipment), general medical equipment, industrial equipment, and automotive
interior applications, etc.

Precautions

Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., specially controlled medical equipment, transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment, etc.).

◆Rated current

1. Rated current of this product is shown in this catalogue, but please be sure to have the base board designed with adequate inspection in case of the generation of heat becomes high within the rated current range when the base board is in high resistance or in bad heating conditions

2. PCB Design

Precautions

◆Land pattern design

1. Please refer to a recommended land pattern.

3. Considerations for automatic placement

Precautions

- Adjustment of mounting machine
 - 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
 - 2. Mounting and soldering conditions should be checked beforehand.

Technical considerations

- ◆Adjustment of mounting machine
 - 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering

♦Wave soldering

1. Please refer to the specifications in the catalog for a wave soldering.

◆Reflow soldering

1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.

◆Lead free soldering

1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, etc. sufficiently.

Precautions

◆Preheating when soldering

Heating : The temperature difference between soldering and remaining heat should not be greater than 150°C .

Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C.

◆Recommended conditions for using a soldering iron

Put the soldering iron on the land-pattern.

Soldering iron's temperature - Below 350°C

Duration - 3 seconds or less

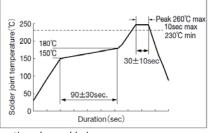
The soldering iron should not directly touch the inductor.

◆Wave, Reflow, Lead free soldering

 If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

[Recommended reflow condition]

Technical considerations



◆Preheating when soldering

- 1. There is a case that products get damaged by a heat shock.
- ◆Recommended conditions for using a soldering iron
 - If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

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5. Handling	
	◆Handling 1. Keep the inductors away from all magnets and magnetic objects.
	♦ Setting PC boards
	1. When setting a chip mounted base board, please make sure that there is no residual stress to the chip by distortion in the board or at screw part.
Precautions	◆Breakaway PC boards (splitting along perforations)
	1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board.
	2. Board separation should not be done manually, but by using the appropriate devices.
	♦ Mechanical considerations
	1. Please do not give the inductors any excessive mechanical shocks.
	♦Handling
	1. There is a case that a characteristic varies with magnetic influence.
	♦ Setting PC boards
Technical	1. There is a case that a characteristic varies with residual stress.
considerations	◆Breakaway PC boards (splitting along perforations)
	1. Planning pattern configurations and the position of products should be carefully performed to minimize stress.
	◆Mechanical considerations
	1. There is a case to be damaged by a mechanical shock.

6. Storage conditions				
Precautions	 ♦ Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. • Recommended conditions Ambient temperature -5~40°C Humidity Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, inductors should be used within 6 months from the time of delivery. 			
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.			

CHIP BEAD INDUCTORS FOR POWER LINES (FB SERIES T TYPE)

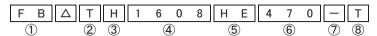
AEC-Q200 Grade 1 (we conduct the evaluation at the test condition of Grade 1.)

*Operating environment Temp:-40~125°C



■PART NUMBER

*Operating Temp. : -40~150°C (Including self-generated heat)



△=Blank space

①Series name

Code	Series name
FB	Ferrite bead

②Shape

Code	Shape
Т	Rectangular chip (High-Reliability)

3Characteristics

-	
Code	Characteristics
Н	High Impedance type

4 Dimensions (L × W)

Ī	Code	Type (inch)	Dimensions (L×W) [mm]
	1608	1608 (0603)	1.6 × 0.8

5Material

Code	Material
HE	Refer to impedance curves
HL	for material differences

6 Nominal impedance

Code (example)	Nominal impedance[Ω]
300	30
221	220
102	1000

Code	Impedance tolerance
_	±25%

O Fackaging	
Code	Packaging
Т	Taping

Туре

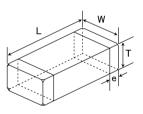
FB TH1608

FEATURES

HE: For upper MHz range applications

HL: For GHz range applications

■STANDARD EXTERNAL DIMENSIONS / STANDARD QUANTITY



Recommended Land Patterns

Surface Mounting

•Mounting and soldering conditions should be checked beforehand.

			С
· A	В	A	

Turno	1	W	т	т .		uantity [pcs]
Туре		VV	'	е	Paper tape	Embossed tape
FB TH1608	1.6±0.15	0.8±0.15	0.8±0.15	0.4±0.2	4000	_
(0603)	(0.063 ± 0.006)	(0.031 ± 0.006)	(0.031 ± 0.006)	(0.015 ± 0.008)		
						Unit:mm(inch)

Code Material		
HE	Refer to impedance curves	
HL	for material differences	

Code (example)	Nominal impedance[Ω]
300	30
221	220
102	1000

7 Impedance tolerance

Code	Impedance tolerance
_	±25%

O I donaging	
Code	Packaging
Т	Taping

В

1.0

С

1.0

Unit:mm

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AUTO

· All the Chip Bead Inductors for Power Lines of the catalog lineup are RoHS compliant

for High Quality Equipment

- The exchange of individual specifications is necessary depending on your application and/or circuit condition. Please contact TAIYO YUDEN's official sales channel.
- For Automotive (AEC-Q200 Qualified) products for POWERTRAIN, and SAFETY. Please check "Automotive Application Guide" for further details before using the products.
 - < AEC-Q200 : AEC-Q200 qualified>

All the Chip Bead Inductors for Power Lines for Automotive products are tested based on the test conditions and methods defined in AEC-Q200 by family item. Please consult with TAIYO YUDEN's official sales channel for the details of the product specifications and AEC-Q200 test results, etc., and please review and approve the product specifications before ordering.

• The products are for Telecommunications infrastructure and Industrial equipment and for Medical devices.

Please consult with TAIYO YUDEN's official sales channel for the details of the product specifications, etc.,

and please review and approve the product specifications before ordering.

Please be sure to contact us for further information in advance when the products are used for automotive electronic equipment.

●FB TH1608HE

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB TH1608HE470-T	47	±25%	100	0.020	2.5	0.8 ±0.15	
FB TH1608HE600-T	60	±25%	100	0.025	2.3	0.8 ±0.15	
FB TH1608HE101-T	100	±25%	100	0.035	1.9	0.8 ±0.15	
FB TH1608HE151-T	150	±25%	100	0.050	1.5	0.8 ±0.15	
FB TH1608HE221-T	220	±25%	100	0.070	1.3	0.8 ±0.15	
FB TH1608HE331-T	330	±25%	100	0.130	0.9	0.8 ±0.15	
FB TH1608HE471-T	470	±25%	100	0.150	0.7	0.8 ±0.15	
FB TH1608HE601-T	600	±25%	100	0.170	0.6	0.8 ±0.15	
FB TH1608HE102-T	1000	±25%	100	0.350	0.5	0.8 ±0.15	

●FB TH1608HL

Part number	Nominal impedance (Ω)	Impedance tolerance	Measuring frequency [MHz]	DC Resistance [Ω](max.)	Rated current [A] (max.)	Thickness [mm]	Note
FB TH1608HL300-T	30	±25%	100	0.028	2.00	0.8 ±0.15	
FB TH1608HL600-T	60	±25%	100	0.045	1.60	0.8 ±0.15	
FB TH1608HL121-T	120	±25%	100	0.130	0.95	0.8 ±0.15	
FB TH1608HL221-T	220	±25%	100	0.170	0.65	0.8 ±0.15	
FB TH1608HL331-T	330	±25%	100	0.210	0.60	0.8 ±0.15	
FB TH1608HL471-T	470	±25%	100	0.350	0.50	0.8 ±0.15	
FB TH1608HL601-T	600	±25%	100	0.450	0.42	0.8 ±0.15	

*) The rated current is the value of current at which the temperature of the element is increased by 25 deg.

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200

100

Frequency[MHz]

1000

10000

100

Frequency[MHz]

1000

10000



100

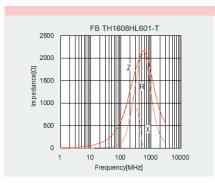
Frequency[MHz]

1000

200

10000

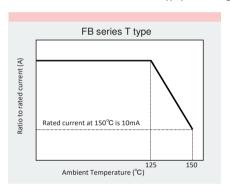
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Derating of Rated Current

●FB series T type

Derating of current is necessary for FB series T type depending on ambient temperature. Please refer to the chart shown below for appropriate derating of current.



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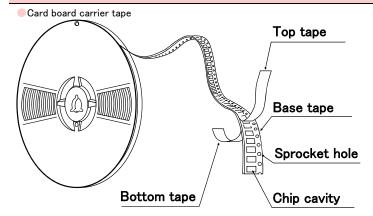
CHIP BEAD INDUCTORS FOR POWER LINES (FB SERIES M TYPE / T TYPE)

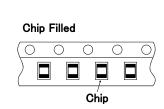
PACKAGING

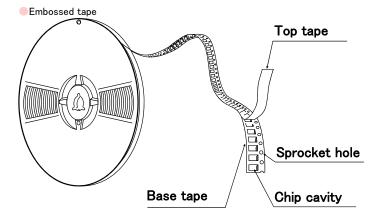
1 Minimum Quantity

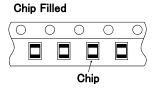
Type	Standard Quantity[pcs]			
туре	Paper Tape	Embossed Tape		
1608 (0603)	4000	1		
2125 (0805)	4000	1		
2012 (0805)	4000	ı		
2016 (0806)	_	2000		
3216(1206)	_	2000		
3225 (1210)	_	1000		
4516(1806)	_	2000		
4525(1810)	_	1000		
4532(1812)	_	2000		

2 Tape Material



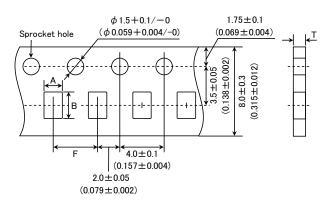






3Taping Dimensions

Paper tape (0.315 inches wide)

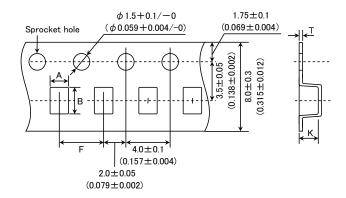


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Туре	Chip	Cavity	Insertion Pitch	Tape Thickness
туре	Α	В	F	Т
FB MJ1608				
FB MH1608	1.0 ± 0.2	1.8±0.2	4.0 ± 0.2	1.1max
FB TH1608	(0.039 ± 0.008)	(0.071 ± 0.008)	(0.157 ± 0.008)	(0.043max)
(0603)				
FB MJ2125	1.5±0.2	2.3±0.2	4.0±0.2	1.1max
FB MH2012	(0.059 ± 0.008)	(0.091±0.008)	(0.157±0.008)	(0.043max)
(0805)	(0.039 ± 0.006)	(0.031 ± 0.006)	(0.137 ± 0.006)	(0.043111ax)

Unit: mm(inch)

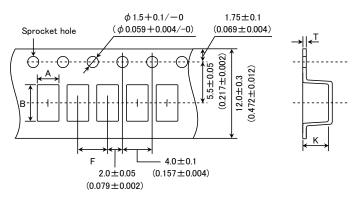
Embossed tape (0.315 inches wide)



Tumo	Chip Cavity		Insertion Pitch	Tape Thickness	
Туре	Α	В	F	K	Т
FB MH2016	1.8±0.2	2.2±0.2	4.0±0.2	2.6max	0.6max
(0806)	(0.071 ± 0.008)	(0.087 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FB MJ3216	1.9±0.2	3.5±0.2	4.0±0.2	1.5max	0.3max
(1206)	(0.075 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.059max)	(0.012max)
FB MH3216	1.9±0.2	3.5±0.2	4.0±0.2	2.6max	0.6max
(1206)	(0.075 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FB MH3225	2.8±0.2	3.5±0.2	4.0±0.2	4.0max	0.6max
(1210)	(0.110 ± 0.008)	(0.138 ± 0.008)	(0.157 ± 0.008)	(0.157max)	(0.024max)

Unit: mm(inch)

Embossed tape (0.472 inches wide)

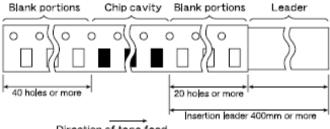


T	Chip	Cavity	Insertion Pitch	Tape Thickness	
Туре	A	В	F	K	Т
FB MJ4516	1.9±0.2	4.9±0.2	4.0±0.2	1.5max	0.3max
(1806)	(0.075 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.059max)	(0.012max)
FB MH4516	1.9±0.2	4.9±0.2	4.0±0.2	2.6max	0.6max
(1806)	(0.075 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.102max)	(0.024max)
FB MH4525	2.9±0.2	4.9±0.2	4.0±0.2	4.0max	0.6max
(1810)	(0.114 ± 0.008)	(0.193 ± 0.008)	(0.157 ± 0.008)	(0.157max)	(0.024max)
FB MH4532	3.6±0.2	4.9±0.2	8.0±0.2	4.0max	0.6max
(1812)	(0.142 ± 0.008)	(0.193 ± 0.008)	(0.315 ± 0.008)	(0.157max)	(0.024max)

Unit: mm(inch)

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4 Leader and Blank portion

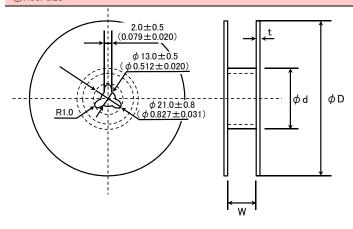


Direction of tape feed

Insertion leader is 400 mm or more (including 20 empty cavities)

Empty cavities at end of reel: 40 holes or more

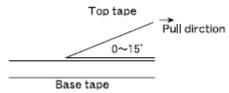
5Reel size



Туре	ΦD	¢ d	W	t
FB MJ1608			10.0±1.5	
FB MJ2125			(0.394 ± 0.059)	
FB MJ3216			(0.394 ± 0.039)	
FB MJ4516			14.0±1.5 (0.551±0.059)	
FB MH1608	180+0/-3	60+1/-0		2.5max
FB MH2012	(7.09+0/-0.118)	(2.36+0.039/-0)	10.0±1.5	(0.098max)
FB MH2016			(0.394 ± 0.059)	
FB MH3216			(0.394 ± 0.039)	
FB MH3225				
FB MH4516			14.0±1.5	
FB MH4525			(0.551 ± 0.059)	
FB MH4532	330±2.0 (12.99±0.080)	100±1.0 (3.94±0.039)	14.0±2.0 (0.551±0.080)	3.0max (1.181max)
ED TILL000	180+0/-3	60+1/-0	10.0±1.5	2.5max
FB TH1608	(7.09+0/-0.118)	(2.36+0.039/-0)	(0.394 ± 0.059)	(0.098max)

Unit: mm(inch)

6Top tape strength



The top tape requires a peel-off force of 0.1 to 0.7N in the direction of the arrow as illustrated below.

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CHIP BEAD INDUCTORS FOR POWER LINE (FB SERIES T TYPE)

■RELIABILITY DATA

1. Operating Tempe	rature Range			
Specified Value	-40°C∼+150°C (Including self-generated heat)			
Test Methods and Remarks	Including self-generated heat			
2. Storage Tempera	ture Range			
Specified Value	-40°C~+125°C			
Test Methods and Remarks	*Note: -5 to +40°C in taped packaging			
3. Impedance				
Specified Value	Within the specified range			
Test Methods and Remarks	Measuring equipment : Impedance analyzer (E4991) or its equivalent Measuring frequency : 100±1 MHz			
4. DC Resistance				
Specified Value	Within the specified range			
Test Methods and Remarks	Four-terminal method Measuring equipment : Milliohm High-Tester 3226 (Hioki Denki) or its equivalent			
5. Rated Current				
Specified Value	Within the specified range			
6. Vibration				
Specified Value	Appearance : No significant abnormality Impedance change : Within ±30% of the initial value			
Test Methods and Remarks	AEC-Q200 Test No.14 qualified (MIL-STD-202 Method 204) The test samples shall be soldered to the test board by the reflow. Then it shall be submitted to below test conditions. Frequency Range 10~2000Hz Total Amplitude 5G Sweeping Method 10Hz to 2000Hz to 10Hz for 20min. Number of cycle Y For 12 cycles on each X, Y, and Z axis.			
7. Mechanical Shock	K.			
	Appearance : No significant abnormality			

7. Mechanical Shoc	k				
Specified Value	Appearance Impedance change	: No significant abnormalit : Within $\pm 30\%$ of the initia			
	AEC-Q200 Test No.13qualified (MIL-STD-202 Method213)				
	The test samples shall be soldered to the test board by the reflow.				
Tark Maklanda and	Then it shall be sub	mitted to below test conditions.			
Test Methods and	Acceleration	981m/s ²			
Remarks	Duration	6msec(Half sine pulse)			
	Direction	+X, +Y, +Z, -X, -Y, -Z			
	Number of time	Each 3 times, Total 18 times			

8. Solderability			
Specified Value	90% or more of immersed surface of terminal electrode shall be covered with fresh solder.		
Test Methods and Remarks	AEC-Q200 Test No.18qual	ified (J-STD-002)	
		(a) Method B	(c) Method D
	Preconditioning	155°C_4hrs	Steam 8hrs±15min
	Solder Temperature	235±5°C	260±5°C
	Time	5+0/-0.5 sec	30+0/-0.5 sec.

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9. Resistance to Soldering Heat				
Specified Value	Appearance Impedance change	: No significant abnormality : Within $\pm 30\%$ of the initial value		
Test Methods and	AEC-Q200 Test No.15 qualified (MIL-STD-202 Method210)			
Remarks	Condition: K The test sample shall be exposed to reflow oven at 183°C for 90-120 seconds, with peak temperature at 250±5°C for 30±5 seconds, 3 times.			

10. Thermal Shock				
Specified Value	Appearance Impedance change	: No significant abnormality : Within \pm 50% of the initial value		
Test Methods and Remarks	The test samples sh time by following co	ndition.	low. The test samples shall be placed at specified temperature for specified	
	1Cycle Number of cycle	-40±3°C/30 min⇔150±3°C/30 min 1000 cycles		

11. Resistance to Humidity (steady state)					
Specified Value	Appearances	: No significant abr	normality		
Specified Value	Impedance change	: Within ±50% of the	ne initial value		
	AEC-Q200 Test No.07 qualified (MIL-STD-202 Method 103)				
	The test samples shall be soldered to the test board by the reflow.				
Test Methods and	The test samples shall be placed in thermostatic oven set at specified temperature and humidity as shown in below table.				
Remarks	Temperature	85±2°C			
	Humidity	85%RH			
	Time	1000+24/-0 hour			

12. High Temperature Exposure				
Specified Value	Appearances Impedance change	: No significant abnormality : Within $\pm 50\%$ of the initial value		
Test Methods and Remarks	AEC-Q200 Test No.03 qualified (MIL-STD-202 Method 108) The test samples shall be soldered to the test board by the reflow soldering. The test samples shall be placed in thermostatic oven set at specified temperature as shown in below table.			
Remarks	Temperature	150±3°C		
	Time	1000+24/-0 hour		

13. High Temperature Loading Test			
Specified Value	Appearance Impedance change	No ignificant abnowithin $\pm 50\%$ of the	•
Test Methods and Remarks	The test samples so the test samples so below table. Temperature Applied current	hall be placed in thermost 125±3°C Rated current	(7) st board by the reflow soldering. atic oven set at specified temperature and applied the rated current continuously as shown in
	Time	1000+24/-0 hour	

Specified Value	Appearance	: No mechanical damage.	
Test Methods and Remarks	The test samples shall	qualified (AEC-Q200-005) be soldered to the test board by the test board reaches to 2 mm for 60 s : 100 × 40 × 1.6 : glass epoxy-resin	e reflow. As illustrated below, apply force in the direction of the arrow indicatings. Force Rod $\frac{20}{R340}$ $\frac{20}{R340}$ $\frac{10}{R340}$ $\frac{20}{R340}$ $\frac{10}{R340}$ \frac

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15. Adhesion of Electrode		
Specified Value	Impedance change : Within ±30% of the initial value	
Test Methods and Remarks	AEC-Q200 Test No.22 qualified (AEC-Q200-006) The test samples shall be soldered to the test board by the reflow soldering. Applied force : 10N Duration : 60 sec.	

Note on standard condition: "standard condition" referred to herein is defined as follows:

5 to 35°C of temperature, 45 to 85% relative humidity and 86 to 106kPa of air pressure.

When there are questions concerning measurement results:

In order to provide correlation data, the test shall be conducted under condition of $20\pm2^{\circ}C$ of temperature, 60 to 70% relative humidity and 86 to 106kPa of air pressure. Unless otherwise specified, all the tests are conducted under the "standard condition."

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CHIP BEAD INDUCTORS FOR POWER LINE (FB SERIES M TYPE / T TYPE)

PRECAUTIONS

1. Circuit Design

◆Operating environment

The products listed in this catalogue are intended for use in general electronic equipment (e.g., AV equipment, OA equipment, home electric
appliances, office equipment, information and communication equipment), general medical equipment, industrial equipment, and automotive
interior applications, etc.

Precautions

Please be sure to contact TAIYO YUDEN for further information before using the products for any equipment which may directly cause loss of human life or bodily injury (e.g., specially controlled medical equipment, transportation equipment including, without limitation, automotive powertrain control system, train control system, and ship control system, traffic signal equipment).

Please do not incorporate our products into any equipment requiring high levels of safety and/or reliability (e.g., aerospace equipment, aviation equipment, nuclear control equipment, undersea equipment, military equipment, etc.).

◆Rated current

1. Rated current of this product is shown in this catalogue, but please be sure to have the base board designed with adequate inspection in case of the generation of heat becomes high within the rated current range when the base board is in high resistance or in bad heating conditions

2. PCB Design

Precautions

◆Land pattern design

1. Please refer to a recommended land pattern.

3. Considerations for automatic placement

Precautions

- Adjustment of mounting machine
 - 1. Excessive impact load should not be imposed on the products when mounting onto the PC boards.
 - 2. Mounting and soldering conditions should be checked beforehand.

Technical considerations

- ◆Adjustment of mounting machine
 - 1. When installing products, care should be taken not to apply distortion stress as it may deform the products.

4. Soldering

♦Wave soldering

1. Please refer to the specifications in the catalog for a wave soldering.

◆Reflow soldering

1. Please contact any of our offices for a reflow soldering, and refer to the recommended condition specified.

◆Lead free soldering

1. When using products with lead free soldering, we request to use them after confirming adhesion, temperature of resistance to soldering heat, etc. sufficiently.

Precautions

◆Preheating when soldering

Heating : The temperature difference between soldering and remaining heat should not be greater than 150°C .

Cooling: The temperature difference between the components and cleaning process should not be greater than 100°C.

◆Recommended conditions for using a soldering iron

Put the soldering iron on the land-pattern.

Soldering iron's temperature - Below 350°C

Duration - 3 seconds or less

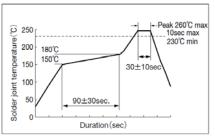
The soldering iron should not directly touch the inductor.

◆Wave, Reflow, Lead free soldering

1. If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

[Recommended reflow condition]

Technical considerations



◆Preheating when soldering

- 1. There is a case that products get damaged by a heat shock.
- ◆Recommended conditions for using a soldering iron
 - If products are used beyond the range of the recommended conditions, heat stresses may deform the products, and consequently degrade the reliability of the products.

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5. Handling						
	◆Handling 1. Keep the inductors away from all magnets and magnetic objects.					
	♦ Setting PC boards					
	1. When setting a chip mounted base board, please make sure that there is no residual stress to the chip by distortion in the board or at screw part.					
Precautions	◆Breakaway PC boards (splitting along perforations)					
	1. When splitting the PC board after mounting inductors, care should be taken not to give any stresses of deflection or twisting to the board.					
	2. Board separation should not be done manually, but by using the appropriate devices.					
	♦ Mechanical considerations					
	1. Please do not give the inductors any excessive mechanical shocks.					
	♦Handling					
	1. There is a case that a characteristic varies with magnetic influence.					
	♦ Setting PC boards					
Technical	1. There is a case that a characteristic varies with residual stress.					
considerations	◆Breakaway PC boards (splitting along perforations)					
	1. Planning pattern configurations and the position of products should be carefully performed to minimize stress.					
	◆Mechanical considerations					
	1. There is a case to be damaged by a mechanical shock.					

6. Storage condi	tions
Precautions	 ♦ Storage 1. To maintain the solderability of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled. • Recommended conditions Ambient temperature -5~40°C Humidity Below 70% RH The ambient temperature must be kept below 30°C. Even under ideal storage conditions, solderability of products electrodes may decrease as time passes. For this reason, inductors should be used within 6 months from the time of delivery.
Technical considerations	◆Storage 1. Under a high temperature and humidity environment, problems such as reduced solderability caused by oxidation of terminal electrodes and deterioration of taping/packaging materials may take place.